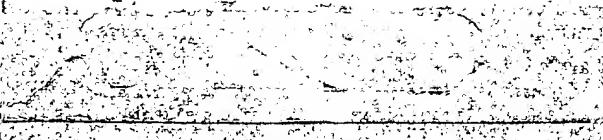


		Subclass					PATENT NUMBER [REDACTED]
		Class					
		ISSUE CLASSIFICATION					
							
U.S. UTILITY Patent Application							
<p style="text-align: center;">O.I.P.E. 07/11 MP Q20 Q.A. 07/11 SCANNED</p> <p style="text-align: center;">KCZ WJ</p>				PATENT DATE			
APPLICATION NO. 09/834014		CONT/PRIOR D	CLASS 438 257	SUBCLASS 783	ART UNIT 2810 2826	EXAMINER ALDUTAR	
APPLICANTS Scott Jacobs							
TITLE Microelectronic packages including thin film metal and dielectric adhesive layer having conductive vias therein							
PTO-2040 12/99							

ISSUING CLASSIFICATION

TERMINAL DISCLAIMER	DRAWINGS			CLAIMS ALLOWED	
	Sheets Drwg.	Figs. Drwg.	Print Fig.	Total Claims	Print Claim for C.G.
<input type="checkbox"/> The term of this patent subsequent to _____ (date) has been disclaimed.				NOTICE OF ALLOWANCE MAILED	
<input type="checkbox"/> The term of this patent shall not extend beyond the expiration date of U.S Patent No. _____				ISSUE FEE	
<input type="checkbox"/> The terminal _____ months of this patent have been disclaimed.				Amount Due	Date Paid
	(Assistant Examiner)	(Date)	(Primary Examiner)	(Date)	
			(Legal Instruments Examiner)	(Date)	ISSUE BATCH NUMBER

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